**Dynamic Contact Electrostatic Force Microscopy (DC-EFM)**

**High Resolution and High Sensitivity Imaging of Electrostatic Force**

**Unique Enhanced EFM Capabilities Provided Only by the Park AFM**

For EFM, the sample surface properties would be electrical properties and the interaction force will be the electrostatic force between the biased tip and sample. However, in addition to the electrostatic force, the van der Waals forces between the tip and the sample surface are always present. The magnitude of these van der Waals forces change according to the tip-sample distance, and are therefore used to measure the surface topography.

Hence, the obtained signal contains both information of surface topography (called 'Topo signal') and information of surface electrical property (called 'EFM signal') generated by the van der Waals and electrostatic forces, respectively. The key to successful EFM imaging lies in the separation of the EFM signal from the entire signal. EFM modes can be classified according to the method used to separate the EFM signal.

**Enhanced EFM**

Three extra EFM modes are supported by the enhanced EFM option of the Park AFM. They are DC-EFM (DC-EFM is patented by Park Systems US Patent 6,185,991), Piezoelectric Force Microscopy (PFM, same as DC-EFM), and Scanning Kelvin Probe Microscopy (SKPM), also known as Surface Potential Microscopy.

In the enhanced EFM of the Park AFM whose schematic diagram is shown in Figure 1, an external Lock-in Amplifier is connected to the Park AFM for two purposes. One purpose is to apply AC bias of frequency $\omega$, in addition to the DC bias applied by the Park AFM controller, to the tip. The other purpose is to separate the frequency $\omega$ component from the output signal. This unique capability offered by the Park AFM enhanced EFM is what excels in performance when compared to the Standard EFM.

![Figure 1. Schematic diagram of the enhanced EFM of the Park AFM.](image)

In the enhanced EFM, the voltage between the tip and the sample can be expressed by the following equation:

$$V(t) = V_{DC} - V_S + V_{AC} \sin \omega t \quad (1)$$

$$F = q \times E = q \times V/d = C \times V^2/d \quad (2)$$

$$F(t) = (C/d) \times V(t)^2 \quad (a)$$

$$= (C/d) \times [(V_{DC} - V_S)^2 + \frac{1}{2} V_{AC}^2] + 2 \times (C/d) \times (V_{DC} - V_S) \times V_{AC} \sin \omega t \quad (b)$$

$$- \frac{1}{2} (C/d) \times V_{AC}^2 \cos 2\omega t \quad (c)$$
V_{DC} is the DC offset potential, and V_s is the surface potential on the sample, and V_{AC} and \omega are the amplitude and frequency of the applied AC voltage signal, respectively. The electrostatic force applied to the cantilever can be expressed by Equation (2), which uses the two-parallel-plate capacitor model to describe the electrostatic interaction between the cantilever and the sample.

Here, F is electrostatic force applied to the tip, q is the charge, E is the electric field, V is the electric potential difference, C is the capacitance, and d is the tip-sample distance. Note that since both AC and DC bias are applied between the tip and the sample, three terms arise in the expression for the force between the tip and the sample. These terms can be referred to as the DC term (a), the \omega term (b), and the 2\omega term (c), respectively. The total cantilever deflection signal, which represents the force between the tip and sample, can be analyzed in terms of its separate parts: DC part, AC part with a frequency of \omega and AC part with a frequency of 2\omega.

The DC cantilever deflection signal can be read directly from the signal channels accessible using XEP Data Acquisition software. The AC parts of the cantilever deflection signal can be read by sending the signal to a Lock-in amplifier, which can read either the part of the signal with a frequency of \omega, or the part of the signal with a frequency of 2\omega. Together, the three signals can be used to gain information about the electrical properties of the sample. For example, the capacitance appears in the equation as the ratio of capacitance to tip-to-sample spacing, C/d. If the tip-to-sample distance is kept constant by the z feedback loop, then C/d is proportional to the capacitance. The \omega signal, which is the coefficient of the term labeled (b) in Equation (2) above, contains contributions from both C/d and the surface potential, V_s. Assuming V_{DC} and V_{AC} are known, you still cannot separate the contributions of the capacitance and the surface potential to the measured \omega signal. However, the 2\omega signal, which is the coefficient of the term labeled (c) above, only includes a contribution from the capacitance. Thus, the 2\omega signal can be used to normalize the \omega signal, isolating the contribution of the surface potential.

Images can be generated from any of the above-mentioned signals. Analysis of an image involves understanding the contributions to the signal used to generate the image.

Why Park AFM Enhanced EFM?

Conventional EFM is operated by unnecessary and inefficient double-pass scan, prohibitively limiting the spatial resolution of surface potential map. The Enhanced EFM by the Park AFM is designed to provide efficient one-pass scan to measure both topography and surface potential simultaneously without losing spatial resolution. Moreover, this allows the two key innovations of the Enhanced EFM:

- High frequency EFM signal measurement in,
  - Surface charge distribution and potential imaging
  - Failure analysis in micro electronics circuitry
  - Mechanical hardness measurement (DC-EFM)
  - Charge densitometry for ferroelectric domain
  - Voltage drop on micro resistors
  - Work function of a semiconductor
DC-EFM (Dynamic Contact EFM) mode is the Enhanced EFM that operates in Contact mode that provides the much improved spatial resolution and more sensitive detection (See Figure 3). Figure 4 makes the comparison of topography and surface charge images of TGS single crystal acquired by DC-EFM (upper) and conventional EFM (lower), respectively. The EFM image taken by conventional EFM shows strong coupling of the topography signal to the image while the image taken by DC-EFM shows complete separation of the topography. The key advantages of DC-EFM are as follows:

- No need of special sample treatment
- High spatial resolution and noninvasive probing.
- Simultaneous topography and domain imaging (Figure 2)
- Real-time imaging of domain dynamics
- Nanoscale control and visualization of domains (Figure 5)
- Detailed local information rather than integral effect

Figure 4. (a) Topography and (b) surface charge image of TGS single crystal by DC-EFM and (c) topography and (d) surface charge image by conventional EFM.

Figure 5. (a) Domain switching behavior in ferroelectric materials. Creation of small domains of TGS by (b) positive applied voltage of 10 V, and (c) negative applied voltage of 10 V.